

Docket No.: JCLA14100

01-11-2005

Form 1595  
1-31-92

RECORDATION FOR

Commerce  
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PATENTS

102917267

12-23-04

To the Honorable Assistant Commissioner for Patents: Please record the attached  
Original documents or copy thereof.1. Name of conveying party(ies) with the  
execution date:KWUN-YAO HO, October 20, 2004  
MORISS KUNG, October 20, 2004

2. Name/address of receiving Party(ies)

VIA TECHNOLOGIES, INC.

8F, NO. 533, CHUNG-CHENG RD.,  
HSIN-TIEN CITY, TAIPEI HSIEN, TAIWAN,  
R.O.C.

3. Nature of conveyance:

☒ Assignment ☐ Security Agreement  
☐ Merger ☐ Change of Name  
☐ Reassignment ☐ OtherAdd'l names of receiving parties  
Attached? ☐ Yes ☒ No

4. Application number(s) or patent number(s):

If this document is being file together with a new application, the execution date of  
the application is October 20, 2004.

A. Patent Application No. (s)

/

Additional number attached?

B. Patent No.(s)

☐ Yes ☒ No5. Name and address of party to whom  
correspondence concerning document  
should be mailed:J. C. Patents  
4 Venture, Suite 250  
Irvine, CA 92618  
(949) 660-07616. Total No. of applications and patents  
involved:

ONE ( 1 )

7. Total fee(37CFR§3.41): \$40.00

☒ Enclosed☒ Charge to Acct. No. 50-0710  
(Order No. JCLA14100)8. Total number of pages, including  
Cover sheet, attachments and Document 3.

Atty Docket No.: JCLA14100

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9. Statement and Signature:

To the best of my knowledge and belief, the forging information is true and  
Correct and any attached copy is a true copy of the original document.

Jiawei Huang

Name of person  
Signing Registration  
No. 43,330

Signature

Date

12/23/2004

01/10/2005 6TON11 00000030 11022244

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PATENT  
REEL: 016130 FRAME: 0795

## ASSIGNMENT

WHEREAS,

1. Kwun-Yao Ho

2. Moriss Kung

hereinafter referred to as ASSIGNOR, has/have invented certain new and useful improvements as described and set forth in the below identified application for United States Letters Patent:

Title: **CHIP CARRIER AND CHIP PACKAGE STRUCTURE THEREOF**

☐ Filed: Serial No.

☒ Executed concurrently with the execution of this instrument

WHEREAS, VIA Technologies, Inc.  
of 8F, No. 535, Chung-Cheng Rd., Hsin-Tien City, Taipei Hsien, Taiwan, R.O.C.

hereinafter referred to as ASSIGNEE, is desirous of acquiring ASSIGNOR'S interest in the said invention and application and in any U.S. Letters Patent which may be granted on the same:

NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN: Be it known that, for good and valuable consideration, receipt of which is hereby acknowledged by Assignor, Assignor has/have sold, assigned and transferred, and by these presents does/do sell, assign and transfer unto the said Assignee, and Assignee's successors and assigns, all his/her/their rights, title and interest in and to the said invention and application and all future improvements thereon, and in and to any Letters Patent which may hereafter be granted on the same in the United States, the said interest to be held and enjoyed by said Assignee as fully and exclusively as it would have been held and enjoyed by said Assignor had this Assignment and transfer not been made, to the full end and term of any Letters Patent which may be granted thereon, or of any division, renewal, continuation in whole or in part, substitution, conversion, reissue, prolongation or extension thereof.

Assignor further agrees/agree that he/she/they will, without charge to said Assignee, but at Assignee's expense, cooperate with Assignee in the prosecution of said application and/or applications, execute, verify, acknowledge and deliver all such further papers, including applications for Letters Patent and for the reissue thereof, and instruments of assignment and transfer thereof, and will perform such other acts as Assignee Lawfully may request, to obtain or maintain Letters Patent for said invention and improvement, and to vest title thereto in said Assignee, or Assignee's successors and assigns.

## ASSIGNMENT CONTINUED

IN TESTIMONY WHEREOF, Assignor has/have signed his/her/their name(s) on the date(s) indicated.

Signature: Kwun-Yao Ho

Date: 2004/10/20

Sole or First Joint Inventor: **Kwun-Yao Ho**

Signature: Moriss Kung

Date: 2004/10/20

Second Joint Inventor(if any): **Moriss Kung**